



Layer Name	Type	Material	Thickness (mm)	Color
F.Silkscreen	Top Silk Screen	Not specified	0 mm	White
F.Paste	Top Solder Paste		0 mm	
F.Mask	Top Solder Mask	Not specified	0.015 mm	Black
F.Cu	copper		0.035 mm	
Dielectric 1	prepreg	FR4-TG140	0.1 mm	FR4 natural
In1.Cu	copper		0.0175 mm	
Dielectric 2	core	FR4-TG140	1.265 mm	FR4 natural
In2.Cu	copper		0.0175 mm	
Dielectric 3	prepreg	FR4-TG140	0.1 mm	FR4 natural
B.Cu	copper		0.035 mm	
B.Mask	Bottom Solder Mask	Not specified	0.015 mm	Black
B.Paste	Bottom Solder Paste		0 mm	
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	White

BOARD CHARACTERISTICS

Copper Layer Count:	4	Board Thickness:	1.6000 mm
Board overall dimensions:	50.8000 mm x 103.0000 mm		
Min track/spacing:	0.1500 mm	Min hole diameter:	0.3000 mm
Copper Finish:	ENIG	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	No		

Drawn by: Heath Raftery
Company: Empirical.EE

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Sheet:
File: Notecarrier-F.kicad_pcb
Title: Notecarrier-F

Size: A4Date: 2023-07-18

KiCad E.D.A. kicad 7.0.5-0

Rev: B
Id: 1/1